

PATENT

N THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kumar et al.

Serial No. 09/903,114

Filed:

July 11, 2001

For:

THERMAL PROCESSING SYSTEM

AND METHODS FOR FORMING LOW-K DIELECTRIC FILMS

SUITABLE FOR INCORPORATION INTO MICROELECTRONIC DEVICES

Docket No.

Examiner:

Group Art Unit: 1762

FSI0006/US/2

B. Talbot

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TC 170

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 I CERTIFY THAT ON <u>OCT 14, 2003</u>, THIS PAPER IS BEING DEPOSITED WITH THE U.S. POSTAL SERVICE AS FIRST CLASS MAIL IN AN ENVELOPE ADDRESSED TO MAIL STOP NON-FEE AMENDMENT, COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313-1450

PAULA J. BREEDEN

RESPONSE

Dear Sir or Madam:

This communication is responsive to the non-final Office Action, mailed July 14, 2003,

regarding the above-mentioned patent Application.

The three-month shortened statutory period for response is set to expire on October 14, 2003. It is respectfully submitted that this response, filed on October 14, 2003, is timely filed within the shortened statutory period. However, if any extension of time is required in order for this paper to be timely filed, then such extension of time is hereby requested and the Commissioner is authorized to charge any extension of time fees to the Kagan Binder deposit account No. 50-1775 and thereafter notify us of the same.

No other fees are believed to be required in connection with the filing of this Response. However, should any fee be required, the Commissioner is authorized to charge such fee(s) to the Kagan Binder Deposit Account No. 50-1775 and thereafter notify us of the same.